Peregrine Semiconductor

UltraCMOS[®] SPDT RF Switch, 10 MHz-40 GHz

Features

- Wideband support up to 40 GHz
- High port to port isolation
 - 48 dB @ 26.5 GHz
 - 39 dB @ 35 GHz
 - 33 dB @ 40 GHz
- Excellent linearity performance
 - P1dB of 31.5 dBm @ 26.5 GHz
 - P1dB of 28.0 dBm @ 35 GHz
 - IIP3 of 50 dBm @ 13.5 GHz
- Low insertion loss
 - 1.8 dB @ 26.5 GHz
 - 3.1 dB @ 35 GHz
- Flip-chip die

Applications

- Test and measurement
- Microwave backhaul
- Radar
- Military communications

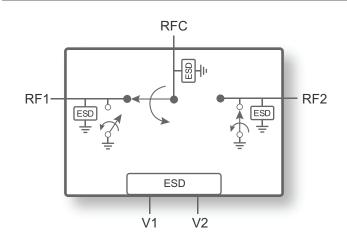


Figure 1 • PE42524 Functional Diagram

Product Description

The PE42524 is a HaRP[™] technology-enhanced reflective SPDT RF switch die that supports a wide frequency range from 10 MHz to 40 GHz. This wideband flip-chip switch delivers high isolation performance, excellent linearity and low insertion loss, making this device ideal for test and measurement (T&M), microwave backhaul, radar and military communications (mil-comm) applications. At 30 GHz, the PE42524 exhibits 17 dB active port return loss, 47 dB isolation and 2.2 dB insertion loss. No blocking capacitors are required if DC voltage is not present on the RF ports.

The PE42524 is manufactured on Peregrine's UltraCMOS[®] process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate.

Peregrine's HaRP technology enhancements deliver high linearity and excellent harmonics performance. It is an innovative feature of the UltraCMOS process, offering the performance of GaAs with the economy and integration of conventional CMOS.

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Absolute Maximum Ratings

Exceeding absolute maximum ratings listed in **Table 1** may cause permanent damage. Operation should be restricted to the limits in **Table 2**. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

ESD Precautions

When handling this UltraCMOS device, observe the same precautions as with any other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified in **Table 1**.

Latch-up Immunity

Unlike conventional CMOS devices, UltraCMOS devices are immune to latch-up.

Table 1 • Absolute Maximum Ratings for PE42524

Parameter/Condition	Min	Мах	Unit
Control voltage (V1, V2)	-3.5	3.5	V
RF input power (RFC–RFX, 50Ω)		Fig. 2	dBm
Storage temperature range	-65	+150	°C
ESD voltage HBM, all pins ^(*)		2000	V
Note: * Human body model (MIL-STD883 Method 3015).			·

Recommended Operating Conditions

 Table 2 lists the recommended operating conditions for PE42524. Devices should not be operated outside the recommended operating conditions listed below.

Table 2 • Recommended Operating Condition for PE42524

Parameter	Min	Тур	Мах	Unit
Control high (V1, V2)	3.1	3.3	3.5	V
Control low (V1, V2)	-3.5	-3.3	-3.1	V
Control current		2		nA
RF input power, CW (RFC–RFX) ⁽¹⁾			Fig. 2	dBm
RF input power, pulsed (RFC–RFX) ⁽²⁾			Fig. 2	dBm
Operating temperature range	-40	+25	+85	°C
Notes: 1) 100% duty cycle, all bands, 50Ω.		•		

2) Pulsed, 5% duty cycle of 4620 μs period, 50 $\!\Omega$.



Electrical Specifications

Table 3 provides the PE42524 key electrical specifications @ 25 °C, V1 = +3.3V, V2 = -3.3V or V1 = -3.3V, V2 = +3.3V (Z_S = Z_L = 50 Ω), unless otherwise specified.

 Table 3 • PE42524 Electrical Specifications

Parameter	Path	Condition	Min	Тур	Max	Unit
Operation frequency			10 MHz		40 GHz	As shown
Insertion loss	RFC-RFX	10 MHz 10 MHz–7.5 GHz 7.5–10 GHz 10–13.5 GHz 13.5–18 GHz 18–20 GHz 20–26.5 GHz 26.5–30 GHz 30–35 GHz 35–40 GHz		0.6 1.0 1.1 1.3 1.4 1.4 1.4 1.8 2.2 3.1 5.5	0.85 1.30 1.50 1.65 1.75 1.75 2.20 2.70 4.10	dB dB dB dB dB dB dB dB dB dB dB
Isolation	All paths	10 MHz 10 MHz–7.5 GHz 7.5–10 GHz 10–13.5 GHz 13.5–18 GHz 18–20 GHz 20–26.5 GHz 26.5–30 GHz 30–35 GHz 35–40 GHz	74 60 58 51 50 49 44 43 35 28	84 64 65 58 53 52 48 47 39 33		dB dB dB dB dB dB dB dB dB dB dB dB dB
Return loss (active port)	RFC-RFX	10 MHz 10 MHz–7.5 GHz 7.5–10 GHz 10–13.5 GHz 13.5–18 GHz 18–20 GHz 20–26.5 GHz 26.5–30 GHz 30–35 GHz 35–40 GHz		25 16 15 17 21 21 18 17 14 6		dB dB dB dB dB dB dB dB dB dB

PE42524 UltraCMOS[®] SPDT RF Switch



Table 3 • PE42524 Electrical Specifications

Parameter	Path	Condition	Min	Тур	Max	Unit
		10 MHz		25		dB
		10 MHZ–7.5 GHz		18		dB
		7.5–10 GHz		19		dB
		10–13.5 GHz		26		dB
Return loss (RFC port)	RFC-RFX	13.5–18 GHz		29		dB
Return loss (RFC port)	RFU-RFA	18–20 GHz		23		dB
		20–26.5 GHz		31		dB
		26.5–30 GHz		30		dB
		30–35 GHz		16		dB
		35–40 GHz		7		dB
		+25 dBm output power, 1 GHz		88		dBc
2nd harmonic, 2fo rejec-	RFC-RFX	+25 dBm output power, 6.5 GHz		84		dBc
tion		+25 dBm output power, 15 GHz		>89 ⁽¹⁾		dBc
Input 1dB compression point ⁽²⁾		10 MHz–40 GHz		Fig. 2		dBm
		10–100 MHz		48		dBm
la sut ID0		1–2 GHz		50		dBm
Input IP3		6–10 GHz		52		dBm
		10–13.5 GHz		50		dBm
Video feedthrough ⁽³⁾		DC measurement		3.5		mV _{PP}
Settling time		50% CTRL to 0.05 dB final value		0.84	1.13	μs
Switching time		50% CTRL to 90% or 10% RF		225	304	ns

Notes:

1) Test system limited.

2) The input 1dB compression point is a linearity figure of merit. Refer to Table 2 for the RF input power (50Ω).

3) Measured with a 3.5 ns rise time, -3.3 / +3.3V pulse and 500 MHz bandwidth.

Control Logic

Table 4 provides the control logic truth table for the PE42524. States 2 and 3 are used in normal switching operations.

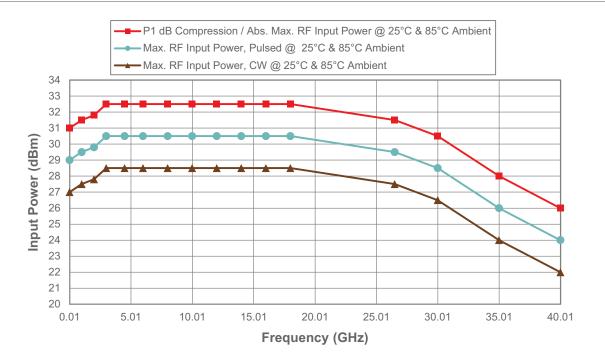
Table 4 • Truth Table for PE42524

V1	V2	RF1	RF2	State
-3.3V	-3.3V	OFF	OFF	1
-3.3V	+3.3V	OFF	ON	2
+3.3V	-3.3V	ON	OFF	3
+3.3V	+3.3V	ON	ON	4





Figure 2 • Power De-rating Curve (10 MHz–40 GHz) @ 25 °C and 85 °C Ambient (50 Ω)

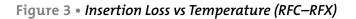






Typical Performance Data

Figure 3–Figure 12 show the typical performance data @ 25 °C, V1 = +3.3V, V2 = -3.3V, unless otherwise specified.



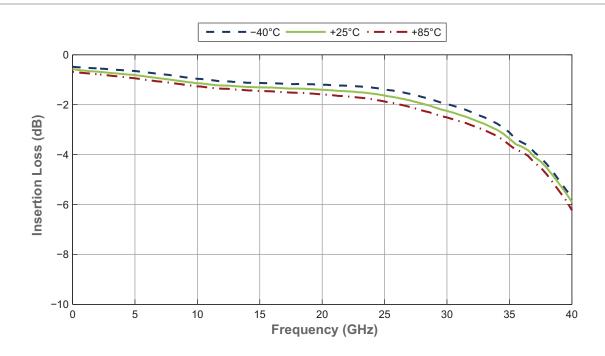
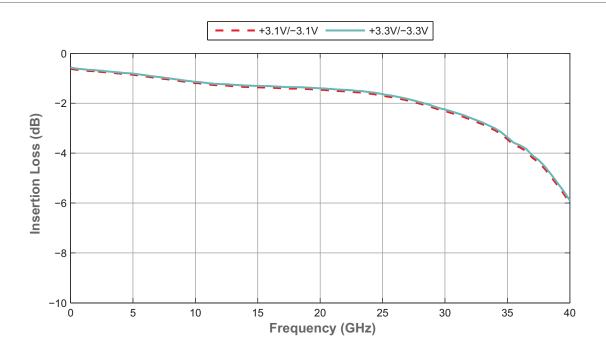
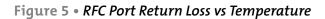


Figure 4 • Insertion Loss vs V1/V2 (RFC-RFX)







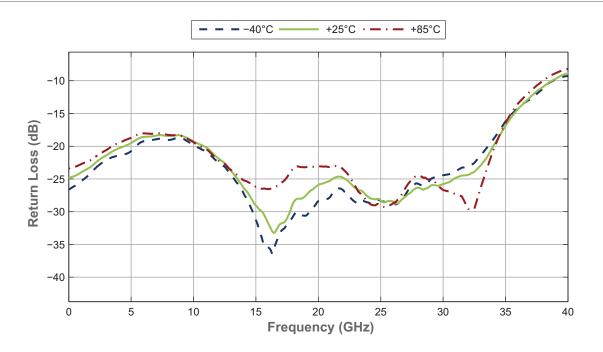
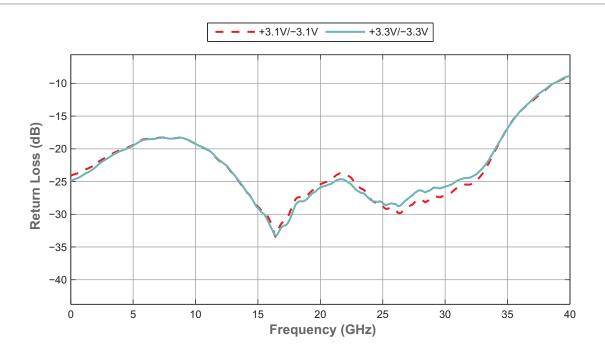


Figure 6 • RFC Port Return Loss vs V1/V2



PE42524 UltraCMOS[®] SPDT RF Switch





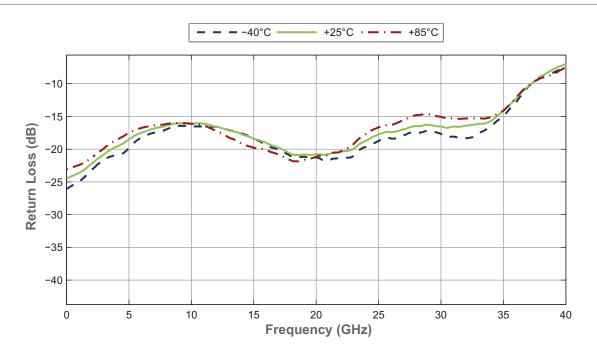


Figure 8 • Active Port Return Loss vs V1/V2

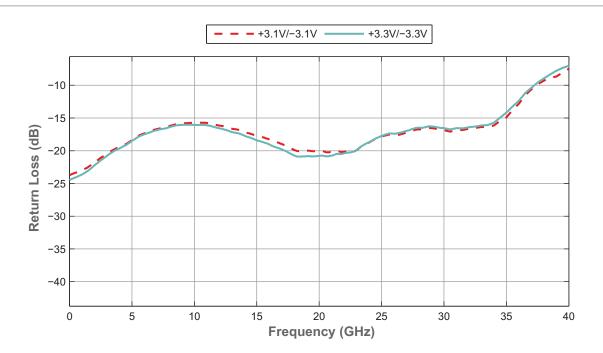




Figure 9 • Isolation vs Temperature (RFX-RFX)

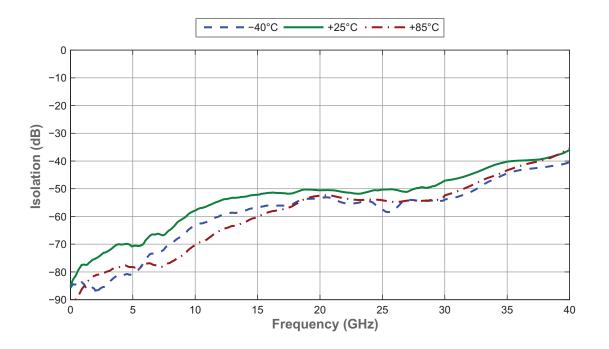
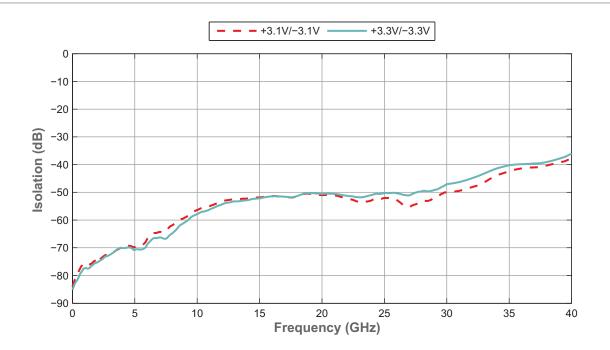


Figure 10 • Isolation vs V1/V2 (RFX-RFX)



PE42524 UltraCMOS[®] SPDT RF Switch



Figure 11 • Isolation vs Temperature (RFC-RFX)

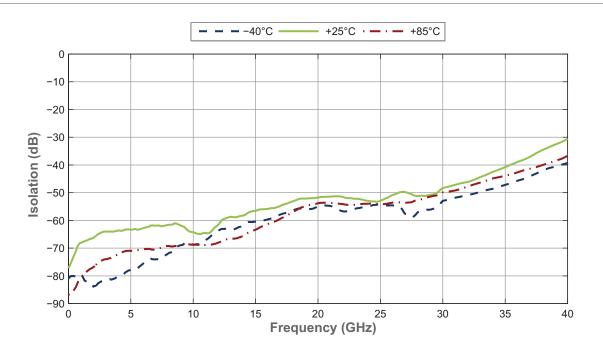
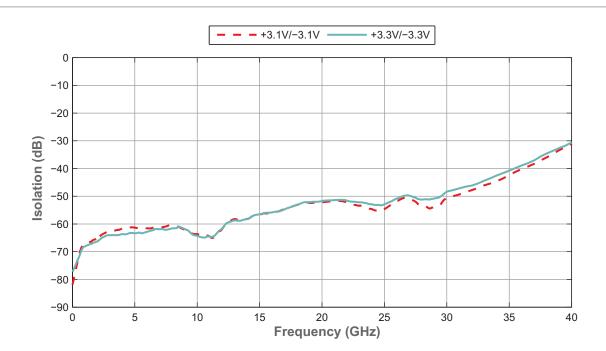


Figure 12 • Isolation vs V1/V2 (RFC-RFX)





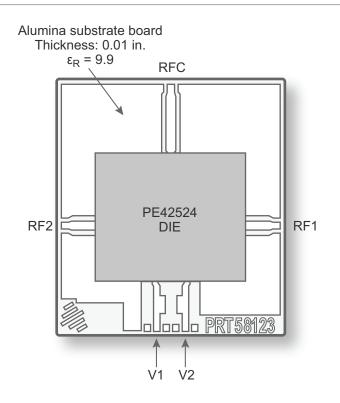
Recommended Evaluation Setup

The PE42524 s-parameter data and input 1dB compression point from 22–40 GHz (**Table 3** and **Figure 3**– **Figure 12**) were taken using grounded co-planar waveguide (CPWG) on the alumina substrate (shown in **Figure 13**) and RF probes.

The PE42524 2nd harmonic, 2fo rejection, input 1dB compression point below 18 GHz, input IP3 measurements, settling time and switching time (**Table 3**) were taken on a PCB using 2.92 mm connectors.

Bypass capacitors are not required.

Figure 13 • Alumina Substrate Board for PE42524





Pin Configuration

This section provides pin information for the PE42524. Figure 14 shows the pin configuration of this device. Table 5 provides a description for each pin.

Figure 14 •	Pin Configuration (Bumps Up) for PE42524
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(9) GND	GND 10 F	GI RFC (1	ND (13) 2 GND
GND ⑧	GND	GND	GND
RF1 ⑦	GND	GND	RF2 15
GNI ©	C		GND ②
GND ⑤	V2 ④	V1 ③	GND ①

Table 5 • Pin Descriptions for PE42524

Pin No.	Pin Name	Description
1, 2, 5, 6, 8–10, 12– 14, 16–19	GND	Ground.
7	RF1	RF port 1.
11	RFC	RF common port.
15	RF2	RF port 2.
3	V1	Control input 1.
4	V2	Control input 2.

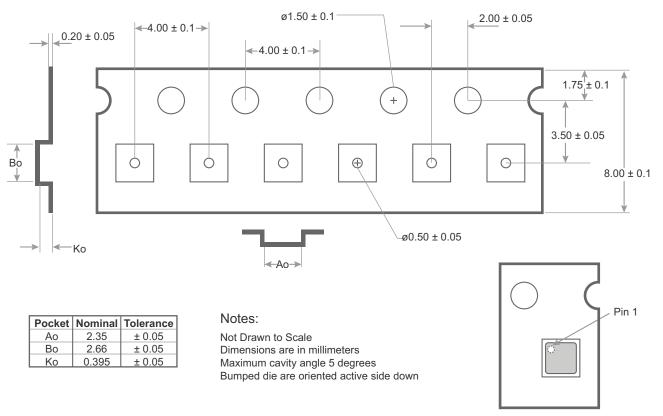




Tape and Reel Specification

This section provides the tape and reel specifications for the PE42524.

Figure 15 • Tape and Reel Specifications for PE42524



Device Orientation in Tape





Not Recommended for New Designs (NRND)

End of Life (EOL)

Obsolete

product.

specific last-time buy date.

This product is in production but is not recommended for new designs.

This product is currently going through the EOL process. It has a

This product is discontinued. Orders are no longer accepted for this

Ordering Information

Table 6 lists the available ordering code for the PE42524 as well as shipping method.

Table 6 • Order Code for PE42524

Order Code	Description	Packaging	Shipping Method
PE42524A–X	PE42524 SPDT RF switch	Die on tape and reel	500 die / T&R

Document Categories

Advance Information

The product is in a formative or design stage. The datasheet contains design target specifications for product development. Specifications and features may change in any manner without notice.

Preliminary Specification

The datasheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product.

Product Specification

The datasheet contains final data. In the event Peregrine decides to change the specifications, Peregrine will notify customers of the intended changes by issuing a CNF (Customer Notification Form).

Sales Contact

For full datasheet or additional information, contact Sales at sales@psemi.com.

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